

Hyperfast Rectifier, 15 A FRED Pt® G5



LINKS TO ADDITIONAL RESOURCES





PRIMARY CHARACTERISTICS							
I _{F(AV)} 15 A							
V_{R}	600 V						
V _F at I _F at 125 °C	1.3 V						
t _{rr} (typ.)	19 ns						
T _J max.	175 °C						
Package	D ² PAK 2L (TO-263AB 2L)						
Circuit configuration	Single						

FEATURES

Best in class forward voltage drop and switching losses trade off



FREE

· Optimized for high speed operation

- 175 °C maximum operating junction temperature
- Polyimide passivation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION / APPLICATIONS

Featuring a unique combination of low conduction and switching losses, this rectifier is the right choice for soft switched and resonant converters, as well as medium frequency hard switching converters. This device is specifically designed to improve efficiency of high speed LLC output rectification stages of EV / HEV battery charging stations and high frequency stages of UPS applications

MECHANICAL DATA

Case: D²PAK 2L (TO-263AB 2L)

Molding compound meets UL 94 V-0 flammability rating

Terminals: matte tin plated leads, solderable per

J-STD-002

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Repetitive peak reverse voltage	V_{RRM}		600	V			
Average rectified forward current	I _{F(AV)}	T _C = 129 °C, D = 0.50	15				
Repetitive peak forward current	I _{FRM}	T _C = 129 °C, D = 0.50, f = 20 kHz	30	Α			
Non-repetitive peak surge current	I _{FSM}	$T_C = 25$ °C, $t_p = 10$ ms, sine wave	185				
Operating junction and storage temperature	T _J , T _{Stq}		-55 to +175	°C			

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Breakdown voltage, blocking voltage	V_{BR} , V_{R}	I _R = 100 μA	600	-	-	.,		
Forward voltage	V _F	I _F = 15 A	-	1.6	2.1	V		
		I _F = 15 A, T _J = 125 °C	-	1.3	-			
Payaraa laakaga aurrant	I _R	$V_R = V_R$ rated	-	-	10			
Reverse leakage current		$T_J = 125 ^{\circ}\text{C}, V_R = V_R \text{rated}$		500	μA			
Junction capacitance	C _T	V _R = 200 V	-	25	-	pF		
Series inductance	L _S	Measured to lead 5 mm from package body	-	8	-	nΗ		



DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)									
PARAMETER	SYMBOL	TEST	MIN.	TYP.	MAX.	UNITS			
		$I_F = 1.0 \text{ A,dI}_F/c$	$dt = 100 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$	1	19	-			
Reverse recovery time	t _{rr}	T _J = 25 °C	T _J = 25 °C	ı	23	-	ns		
		T _J = 125 °C		ı	36	-	1		
Poak rocovony current	I_{RRM} $T_{J} = 25 ^{\circ}C$ $I_{F} = 10 ^{\circ}A$ $I_{F} = 100 ^{\circ}A$	1	12	-	Α				
Peak recovery current		T _J = 125 °C	V _R = 400 V	-	20	-			
Poverse recovery charge	Q _{rr}	T _J = 25 °C		-	180	-	nC		
Reverse recovery charge		T _J = 125 °C		-	472	-			
Reverse recovery time		T _J = 25 °C	I _F = 15 A dI _F /dt = 1000 A/μs V _B = 400 V	-	33	-	ns		
neverse recovery time	t _{rr}	T _J = 125 °C		-	44	-			
Dook receiver ourrent	I _{RRM}	T _J = 25 °C		-	13	-	А		
Peak recovery current		T _J = 125 °C		-	21	-			
Reverse recovery charge	0	T _J = 25 °C		-	220	-	nC		
	Q _{rr}	T _J = 125 °C		-	578	-			

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Thermal resistance, junction-to-case	R _{thJC}		-	ı	1.72	°C/W		
Weight			-	2.0	-	g		
Maximum junction and storage temperature range	T _J , T _{Stg}		-55	-	175	°C		
Marking device		Case style D ² PAK 2L (TO-263AB 2L)	E5TX1506S					

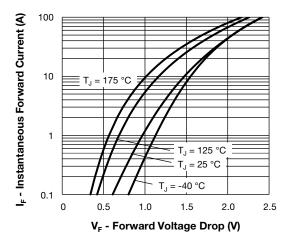


Fig. 1 - Forward Voltage Drop Characteristics, Per Leg

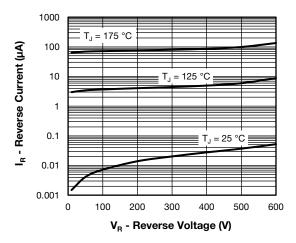


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage,

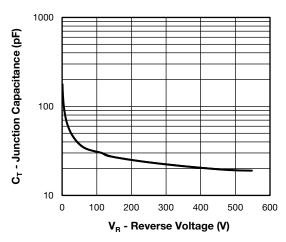


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage, Per Leg

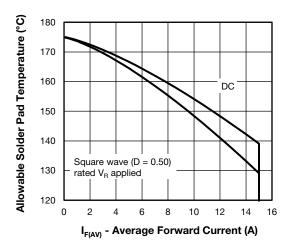


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current, Per Leg

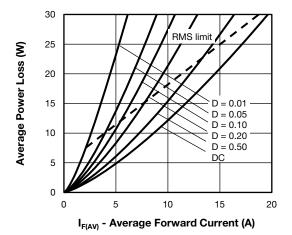


Fig. 5 - Forward Power Loss Characteristics, Per Leg

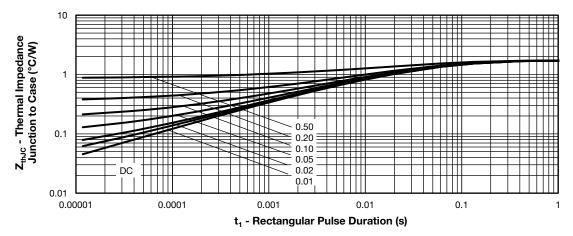


Fig. 6 - Transient Thermal Impedance, Junction to Case, Per Leg

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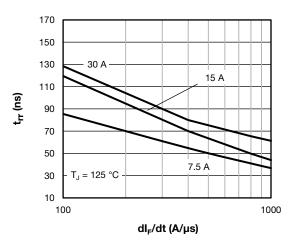


Fig. 7 - Typical Reverse Recovery Time vs. dl_F/dt, Per Leg

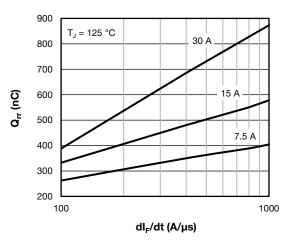


Fig. 8 - Typical Reverse Recovery Charge vs. dl_F/dt, Per Leg

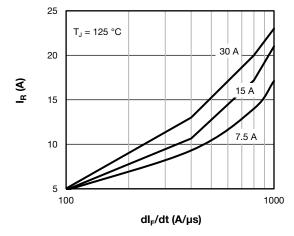


Fig. 9 - Typical Reverse Recovery Current vs. dI_F/dt , Per Leg

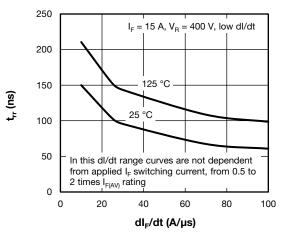


Fig. 10 - Typical Reverse Recovery Time vs. dl_F/dt, Per Leg

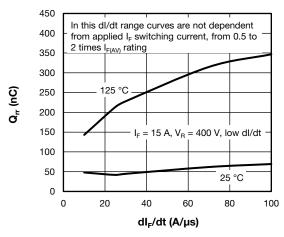


Fig. 11 - Typical Reverse Recovery Charge vs. dI_F/dt, Per Leg

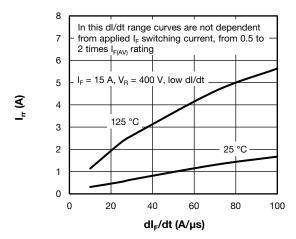


Fig. 12 - Typical Reverse Recovery Current vs. dI_F/dt , Per Leg

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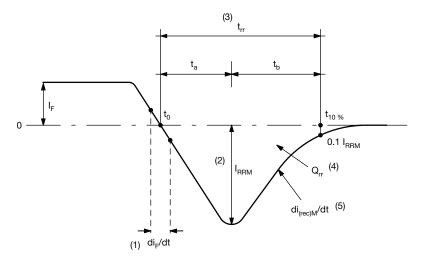


Fig. 13 - Reverse Recovery Waveform and Definitions

Notes

- (1) di_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- $^{(3)}$ t_{rr} reverse recovery time measured from t_0 , crossing point of negative going I_F , to point $t_{10\%}$, 0.1 I_{RRM}
- $^{(4)}$ Q_{rr} area under curve defined by t_0 and $t_{10}\,\%$

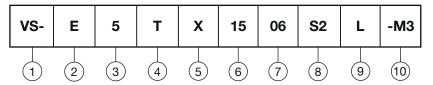
$$Q_{rr} = \int_{t_0}^{t_{10}\%} I(t)dt$$

 $^{(5)}$ $di_{(rec)}M/dt$ - peak rate of change of current during t_{b} portion of t_{rr}



ORDERING INFORMATION TABLE

Device code



- Vishay Semiconductors product

2 - E = single diode

3 - 5 = FRED generation 5

4 - Package:

10

 $T = D^2PAK$ (TO-263) package

5 - X = hyperfast recovery

6 - Current rating (15 = 15 A)

7 - Voltage rating (12 = 1200 V)

8 - S2 = true 2 pin D^2PAK

9 - None = tube (50 pieces)

• L = tape and reel (left oriented, for D²PAK package)

If needed different orientation/packaging, please contact factory

Environmental digit:

-M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

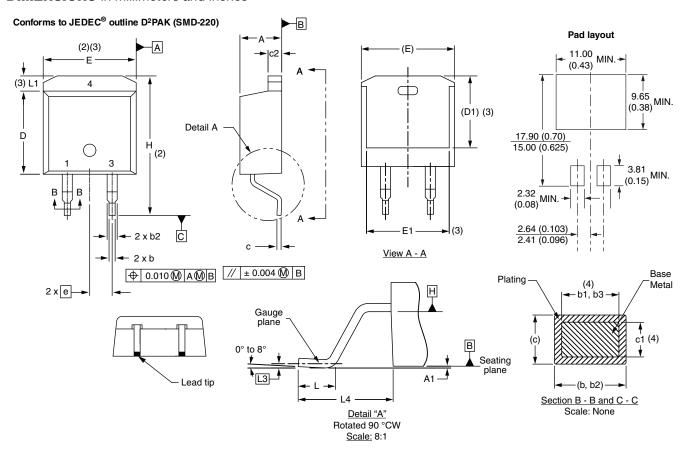
ORDERING INFORMATION (Example)							
PREFERRED P/N BASE QUANTITY PACKAGING DESCRIPTION							
VS-E5TX1506S2L-M3	800	13" diameter reel					

LINKS TO RELATED DOCUMENTS					
Dimensions	www.vishay.com/doc?96683				
Part marking information	www.vishay.com/doc?96693				
Packaging information	www.vishay.com/doc?95032				



D²PAK 2L (TO-263AB 2L)

DIMENSIONS in millimeters and inches



SYMBOL	MILLIM	IETERS	INCHES		NOTES
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190	
A1	0.00	0.254	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2

SYMBOL	MILLIM	ETERS	INCHES		NOTES
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54	2.54 BSC		0.100 BSC	
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	-	0.066	3
L3	0.25 BSC		0.010	BSC	
L4	4.78	5.28	0.188	0.208	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC® outline TO-263AB



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